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# Surface modification and thermal performance of a graphene oxide/novolac epoxy composite

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Functionalized graphene oxide (GO) was successfully modified by grafting 1,3,5-triglycidylisocyanurate (TGIC) onto the surface of GO. The modified GO was then added to a novolac epoxy composite at various volume fractions to improve the interfacial compatibility between the filler and matrix. Samples of the modified GO/novolac epoxy composite were fabricated through the hot-pressing method. Microstructural analysis revealed that the modified GO dispersed well in the matrix and formed thermal conductive pathways across the matrix. The thermal degradation temperature of 50% weight loss of the modified GO/novolac epoxy composite was 166 °C higher than that of the novolac epoxy. The data for loss factor  $\tan \delta$  demonstrated that when the composite contained 36.8 wt% of modified GO, the glass transition temperature of the modified GO/novolac epoxy composite was 222 °C, which is 90 °C higher than that of the novolac epoxy. The thermal conductivity of the modified GO/novolac epoxy composite improved from 0.044 W m<sup>-1</sup> K<sup>-1</sup> to 1.091 W m<sup>-1</sup> K<sup>-1</sup>. Results indicated that the incorporation of surface-modified GO into the novolac epoxy positively affects the thermal conductivity and various properties of the modified GO/novolac epoxy composite.

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## 1. Introduction

Electronic products have been miniaturized and integrated as a result of improved technical requirements and changing consumer demands. Heat dissipation, however, is one of the most important problems associated with and encountered in the operation of miniaturized devices.<sup>1</sup> Heat dissipation affects the service life of the product and user experience.<sup>2</sup> Therefore, several studies have attempted to find effective solutions to heat dissipation. Given their good heat dissipation properties, thermal interface materials have been widely used as heat dissipaters in integrated circuits and electronic devices.<sup>3</sup> The potential application of resin materials as heat dissipaters has recently attracted considerable attention due to their good thermal stability and excellent mechanical properties.<sup>4</sup> However, their further application is limited by their low thermal conductivity.

Resin composites with excellent thermal properties can be fabricated using polymer matrices modified with fillers that exhibit high thermal conductivity. Compared with that of metals, metal oxides, and nitrides,<sup>5</sup> the use of carbon materials as fillers has received more research attention because of their outstanding thermal performance. Common carbon fillers

include graphite, carbon black, carbon nanotubes, and diamonds. Among these fillers, graphene exhibits many advantages, such as high thermal conductivity and favorable thermal stability.<sup>6</sup> In addition, graphene can tightly couple with matrix materials.<sup>7–9</sup> Nevertheless, the aggregation caused by molecular interactions<sup>10–12</sup> and compatibility between the graphene and polymer matrix<sup>13</sup> may directly affect the performance of the graphene-modified composite. Therefore, graphene has to be subjected to surface modification, such as grafting with organic molecules.<sup>14</sup> Surface modification is based on an initial oxidation process. After oxidation, the surface of graphene is modified with different functional groups, such as epoxy, hydroxyl, and carboxyl. Several studies have been performed on the functionalization of graphene with polar groups.

Given that the good dispersion of the filler in the matrix is an essential property of thermal conductive materials, the dispersion degree of the filler should be improved by increasing interfacial compatibility. Wan<sup>15</sup> prepared DGEBA-functionalized graphene oxide (GO) (DGEBA-f-GO) and reported that the dispersion of DGEBA-f-GO sheets in epoxy resin is better than that of GO sheets. Increasing the grafting rate is another approach to improve interfacial compatibility. Lin<sup>16</sup> grafted APTES onto GO sheets and then grafted maleic anhydride-grafted polyethylene onto the APTES-coated graphene with high grafting efficiency. The crystallization temperature of the modified polymer was 10 °C higher than that of the pure polymer. Notably, surface modification affected not only the interfacial property but also the mechanical property of the composite. Xia<sup>17</sup> prepared GO-hybridized polyurethane/

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epoxy interpenetrating polymer networks through *in situ* polymerization. The prepared polymer networks exhibited good mechanical performance due to the formation of chemical bonds. Given that grafting remarkably improves interfacial compatibility, it may be worth applying in the fabrication of composites with desirable thermal conductivity.

In this study, GO was prepared through a modified Hummer's method and then grafted with ring-opened 1,3,5-triglycidylisocyanurate (TGIC) to improve its interfacial compatibility with the matrix. Novolac epoxy, a thermoplastic resin that is widely used in the production of structural parts and electrical components,<sup>18</sup> was selected as the matrix. The modified GO is expected to provide uniform heat conduction pathways and improve the thermal performance of the modified GO/novolac epoxy composite. The curing time, curing temperature, and curing process of novolac epoxy were also explored in this study. The influence of the functionalized graphene on the property of the composites was also discussed.

## 2. Experimental

### 2.1 Materials

Natural flake graphite (NG) was supplied by Kuntai Graphite Co., Ltd. (China). Novolac epoxy was procured from Hunan JSD Materials Technology Co., LTD. TGIC was supplied by Aladdin Industrial Corporation, Shanghai, China. All other reagents, such as 98% H<sub>2</sub>SO<sub>4</sub>, KMnO<sub>4</sub>, H<sub>2</sub>O<sub>2</sub>, lactic acid, DMF, and melamine, were all of analytical grade.

### 2.2 Preparation of GO

GO was synthesized through the modified Hummer's method. After oxidation, the basal spacing of GO increased. Oxygen-containing functional groups, such as epoxy, hydroxyl, and carboxyl, were then introduced on the surface of GO.<sup>19</sup> These functional groups facilitated further surface modification. GO preparation is schematically shown in Fig. 1(a) and proceeded as follows: first, H<sub>2</sub>SO<sub>4</sub> (35 mL) was added to NG (1.5 g) in a three-necked round-bottomed flask (150 mL) and stirred for 30 min at room temperature. KMnO<sub>4</sub> (3 g) was added slowly to the mixture, and the mixture was stirred for at least 2 h in an ice bath and then heated to 35 °C under vigorous stirring for 30 min. Then, 150 mL deionized water was gradually added to the reaction solution, which had a temperature of 98 °C, under vigorous stirring for 15 min. Finally, 10 mL H<sub>2</sub>O<sub>2</sub> was added to the solution, which was then stirred for 10 min. The reaction solution was centrifuged and then washed repeatedly with distilled water until the solution was almost neutral. The products were then immersed in 70% aqueous alcohol solution and treated in an ultrasonic bath for 2 to 3 days. The final product was stored until use.

### 2.3 GO functionalization

TGIC was selected as the small organic molecule for the surface modification of GO. TGIC is a trifunctional monomer with triazine structure and contains three symmetrically distributed active epoxy groups.<sup>20,21</sup> The epoxy groups of TGIC were opened

and hydroxyl groups were introduced after the ring-opening reaction. Grafting lactic acid molecules onto the molecular chain of the ring-opened products produced another hydroxyl. GO functionalization is shown schematically in Fig. 1(b) and proceeded as follows: first, a certain amount of TGIC and lactic acid at a molar ratio of 3 : 1 was mixed in a 150 mL three-necked round-bottomed flask. The reaction mixture was stirred for 8 h at 110 °C in an oil bath.<sup>22</sup> The final product was the ring-opened TGIC.

### 2.4 Preparation of grafted graphite

The surface of graphene produced oxygen-containing functional groups after oxidation. The carboxyl groups located on the GO surface will react with the hydroxyl groups of the ring-opened TGIC in a condensation reaction. Surface modification will improve interfacial compatibility between the filler and matrix. The preparation of grafted graphite is shown schematically in Fig. 1(c) and proceeded as follows: GO and ring-opened TGIC were placed in a DMF solution, mixed in a 150 mL three-necked round-bottomed flask, and stirred for 8 h in a water bath at 80 °C.<sup>23</sup> The reaction solution was centrifuged, washed repeatedly with distilled water until the solution became almost neutral, and dried in a drying oven at 70 °C. The final product was stored until use.

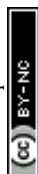
### 2.5 Preparation of the compound material

The thermally conductive composite, which is based on novolac epoxy, was prepared through the mold pressing method. Melamine was selected as the curing agent. To ensure good mixing, the filler, curing agent, and matrix were ground before mixing. First, the mixed powder was placed into the molding and cold-pressed at room temperature for 10 min. Then, the molding was transferred to an oven at 160 °C until the mixed powder turned into an elastomer. Finally, the molding was molded using a hydraulic press at 160 °C for 1 h. The weight percentage of modified GO in the composite varied from 0.58% to 36.8%. The weight percent of the curing agent was 20%. The density of GO and novolac epoxy were 0.84 and 1.2 g mL<sup>-1</sup>, respectively, and were obtained through the drainage method.

### 2.6 Characterization

Fourier transform infrared (FTIR) spectroscopy was performed on an IR Prestige-21/FTIR-8400S FTIR spectrometer. GO and the modified GO/novolac epoxy composite were morphologically characterized through scanning electron microscopy (SEM) (SU 8000) and transmission electron microscopy (TEM) (JEM-3010). SEM images were obtained with an operating voltage of 1 kV. TEM samples were dispersed in an ethanol solution and spooned out with a copper net for observation.

Thermogravimetric analysis (TGA) was performed to observe the thermal stability of the modified GO/novolac epoxy composite. TGA was performed on a NETZSCH TG 209F3 instrument from room temperature (RT) to 900 °C at a linear heating rate of 5 °C min<sup>-1</sup> under an N<sub>2</sub> atmosphere (flow rate of 30 mL min<sup>-1</sup>).



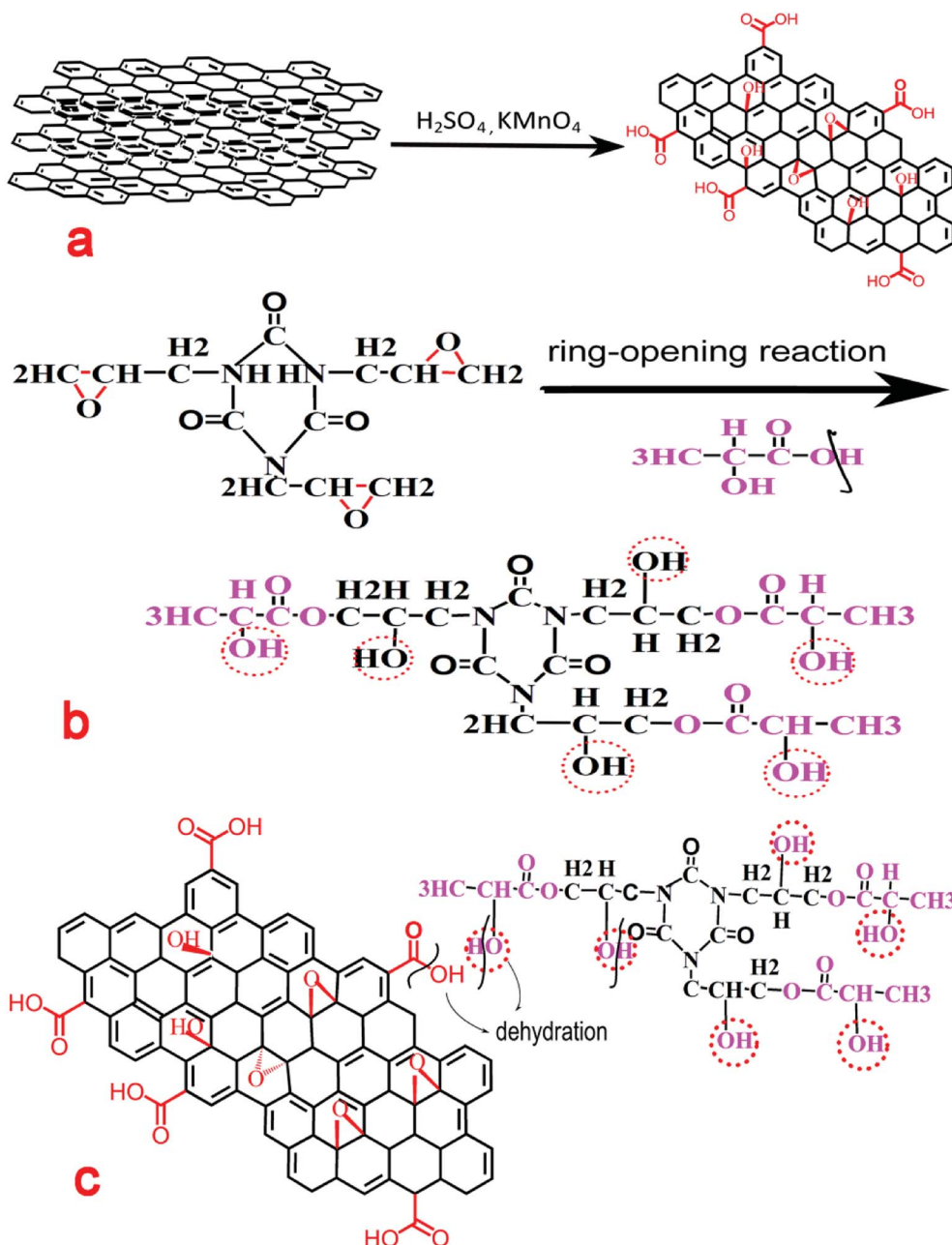


Fig. 1 Schematic of GO functionalization.

Differential scanning calorimetry (DSC) was performed on a NETZSCH DSC 200F3 instrument from RT to 300 °C at a linear heating rate of 5 °C min<sup>-1</sup> under an N<sub>2</sub> atmosphere (flow rate of 60 mL min<sup>-1</sup>).

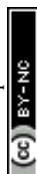
Dynamic thermomechanical analysis (DMA) of novolac epoxy and modified GO/novolac epoxy composite were performed on a DMA 1 (Mettler Toledo) instrument. Samples with a dimension of 20 × 10 × 2 mm<sup>3</sup> were measured from RT to 300 °C at a linear heating rate of 5 °C min<sup>-1</sup>.

Thermal conductivity was characterized using a NETZSCH LFA 457 MicroFlash. Each sample was tested thrice to decrease test errors. The sample was cut from the original sample and polished into a  $\phi$ 10 wafer with a density of 2–3 mm.

## 3. Results and discussion

### 3.1 TEM

Fig. 2 shows the microscopy images of modified GO obtained under different magnifications. Fig. 2(a) shows the image of the modified GO. Black dots were scattered at the edge of GO. The active functional groups at the edge of GO were identified as the carboxyl and epoxy groups.<sup>24,25</sup> The grafting reaction mainly occurred between the carboxyl group and TGIC. Therefore, the black dots were identified as TGIC. Fig. 2(b) to (d) show the different forms of the modified GO. During GO surface modification, the shape and size of the microstructure of the organic molecule can be influenced by the oxidation degree of the





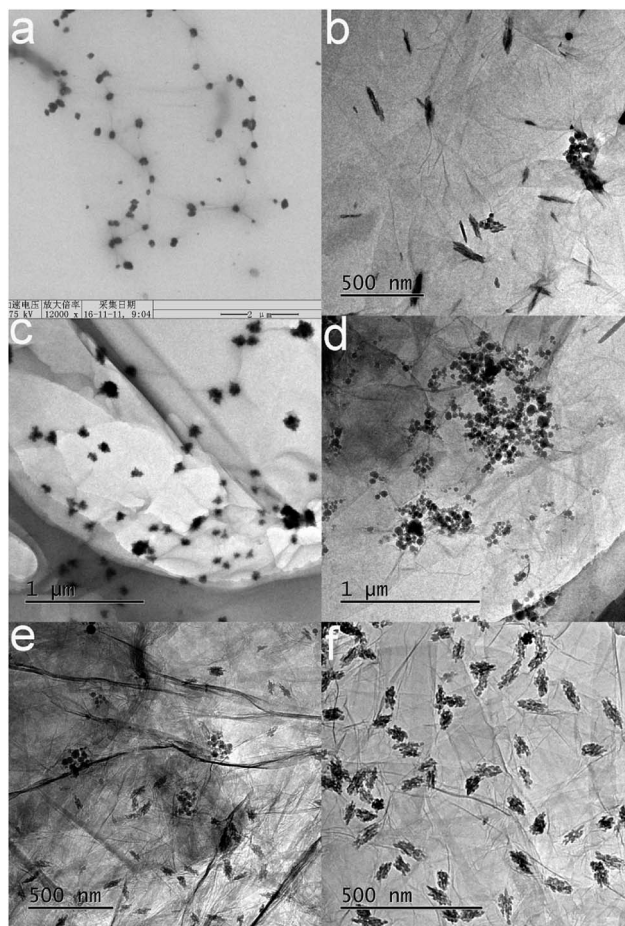


Fig. 2 TEM micrographs of modified GO.

graphite, the ring-opened rate of the epoxy group in TGIC, the reactive site, and the rate of the grafting reaction. Therefore, the forms of TGIC are not the same. Three kinds of morphologies are presented in Fig. 2: a willow-leaf shape in Fig. 2(b), irregular polygons in Fig. 2(c), and spheres in Fig. 2(d). The coexistence of leaf-shaped and spherical organic molecules in Fig. 2(e) provides evidence that morphological changes had occurred. The aggregation of TGIC can be observed in Fig. 2(d). The degree of aggregation is dependent on the joining speed and order of the reactants. If GO is added to the ring-opened TGIC, the ring-opened TGIC may agglomerate. If reactants are added

in reverse order, the ring-opened TGIC may disperse more uniformly and improve the grafting effect, as confirmed by the data shown in Fig. 2(f).

### 3.2 FTIR

Fig. 3 shows the FTIR spectra of TGIC, ring-opened TGIC, GO, and modified GO. Fig. 3(a) shows a magnified image of Fig. 3(b). TGIC is an ether with three epoxy groups. The characteristic peaks of the epoxy group in ether were present in the regions of 1280–1240  $\text{cm}^{-1}$  (8  $\mu\text{peak}$ ) and 840–750  $\text{cm}^{-1}$  (12  $\mu\text{peak}$ ). The band at 840 and 1251  $\text{cm}^{-1}$  in the spectrum of TGIC in Fig. 3(a) was attributed to the stretching vibrations of the epoxy group. After the ring-opened reaction, the peak strength at the corresponding position of the black curve in Fig. 3(a) considerably weakened, demonstrating that the epoxy group in TGIC had opened. Another characteristic functional group in TGIC is carbonyl ( $\text{C}=\text{O}$ ), which has a characteristic peak at 1750–1680  $\text{cm}^{-1}$ .<sup>26</sup> The characteristic peak of carbonyl ( $\text{C}=\text{O}$ ) was found at 1695  $\text{cm}^{-1}$  in the spectrum shown in Fig. 3(b). The ring-opening reaction produced numerous hydroxyl groups. The broad peak at 3373  $\text{cm}^{-1}$  shown in Fig. 3(b) can be attributed to the presence of hydroxyl groups. The opening of the epoxy group and the formation of hydroxyl in TGIC can be deduced from the above analysis. In Fig. 3(c), the peaks at 1311 and 1485, 1745, and 3166  $\text{cm}^{-1}$  were attributed to the alcoholic hydroxyl group, carbonyl group, and hydroxyl group, respectively.<sup>27</sup> After surface modification, new characteristic peaks formed at 1218, 1735, and 3375  $\text{cm}^{-1}$  and were attributed to the C–N bond, carbonyl group, and hydroxyl group, respectively.<sup>28,29</sup> The appearance of the above three characteristic peaks matched the reaction mechanism shown in Fig. 1 and fully demonstrated that the ring-opened TGIC was successfully grafted on GO.

### 3.3 SEM

The SEM images of novolac epoxy and the modified GO/novolac epoxy composite are shown in Fig. 4. The weight percentage of modified GO in the composites from Fig. 4(a) to (f) was 0, 5.5 wt%, 14.9 wt%, 22.6 wt%, 29 wt%, 34.4 wt% separately in Fig. 4(a), the cross-section morphology of novolac epoxy is considerably smoother than that of the modified GO/novolac epoxy composite. Black dots are visible in Fig. 4(b). Some of these black dots, which were identified as modified GO,

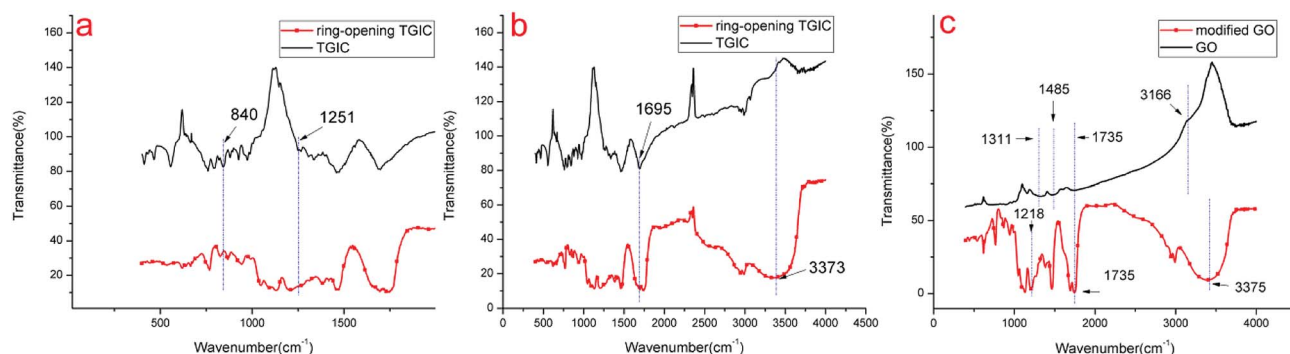


Fig. 3 FTIR spectra of ring-opened TGIC (a and b) and TGIC, modified GO and GO (c).



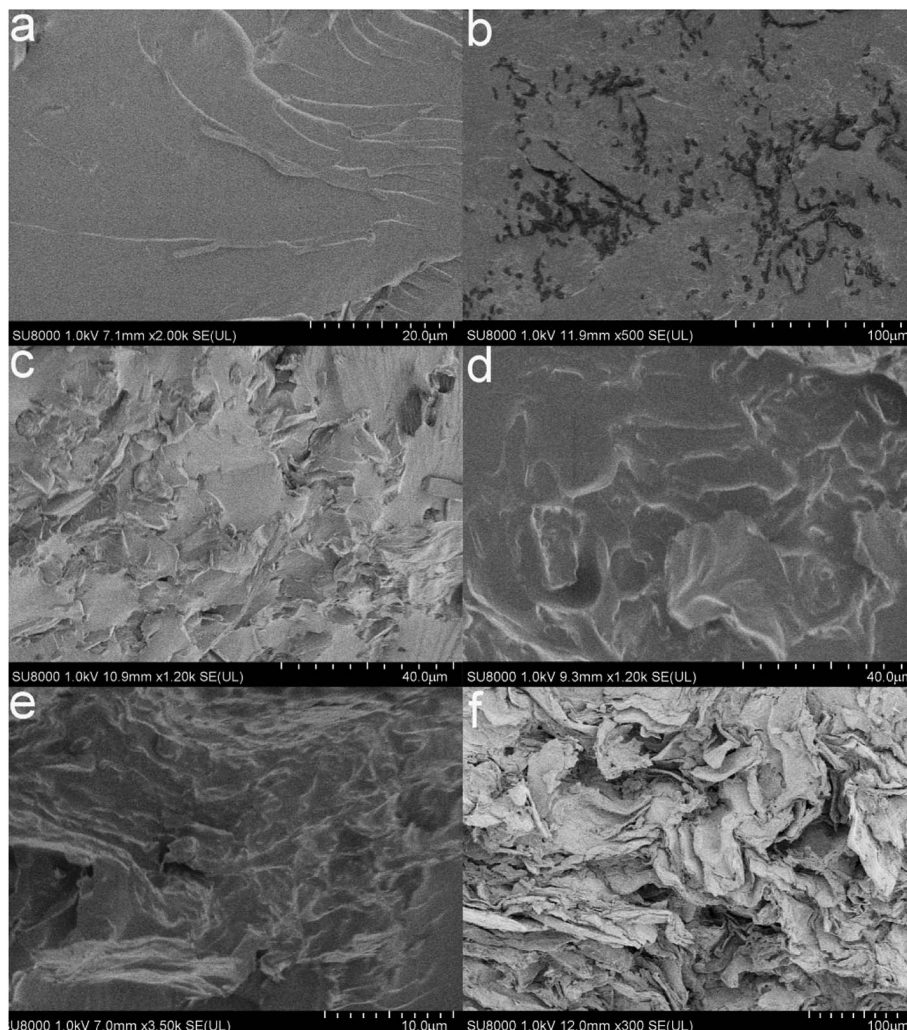


Fig. 4 SEM images of pure novolac epoxy (a) and modified GO/novolac epoxy composite ((b) (5.5 wt%), (c) (14.9 wt%), (d) (22.6 wt%), (e) (29 wt%), and (f) (34.4 wt%)).

remained isolated, whereas some were in contact with each other. As shown in Fig. 4(c) and (d), modified GO combined well with the matrix and distributed uniformly.<sup>30–32</sup> Fig. 4(e) and (f) illustrate the formation of heat conduction pathways with the increasing weight percentage of modified GO in the composite. The formation of the heat conduction pathways<sup>33</sup> can be deduced on the basis of the above analysis. The thermal property will increase with increasing filler content. However, the increase in filler content will also negatively affect the comprehensive performances, such as mechanical property, of the composite. Therefore, all results should be considered for the selection of the optimal proportion of modified GO.

### 3.4 TGA

Fig. 5 shows the weight loss curves of the novolac epoxy and modified GO/novolac epoxy composite. This figure demonstrates that the decomposition trends of the 11 curves are all the same. Novolac epoxy exhibited the lowest residue weight when the increase in temperature was terminated. The residue weight increased gradually with the increasing weight percentage of

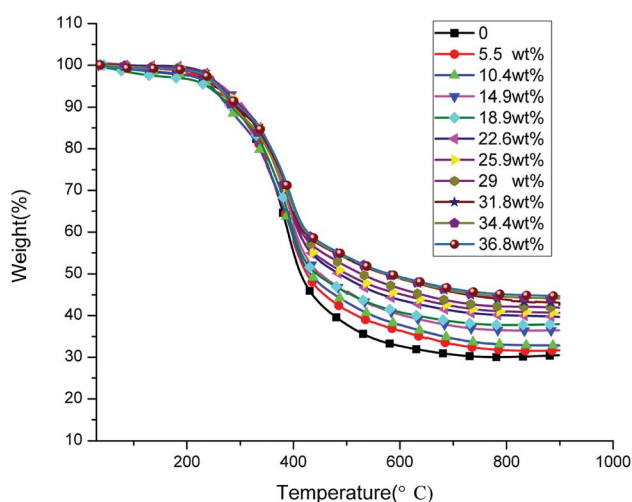


Fig. 5 TG curves of novolac epoxy and modified GO/novolac epoxy composite.





modified GO in the composite. The corresponding TGA parameters are shown in Table 1. The 5% weight loss temperature for novolac epoxy was 251 °C. The 5% weight loss temperature of the modified GO/novolac epoxy composites were all higher than that of novolac epoxy when the weight percentage of modified GO in the composite reached 5.5%, 10.4%, and 14.9%. By contrast, the 5% weight loss temperature of the modified GO/novolac epoxy composites decreased when the weight percentage of modified GO in the composite reached 18.9%. This trend occurred because the thermal conductivity of the composite improved as the filler content increased. The heat transfer to internal novolac epoxy was accelerated, thus increasing the weight-loss ratio in the low-temperature region. In the meantime, the basic pathway of thermal conductivity was formed. The agglomeration and uneven dispersion of fillers in the matrix were inevitable. Therefore, the 5% weight loss temperature slightly fluctuated as the weight percentage of modified GO in the composite continuously increased. When the temperature increased to 200 °C, labile oxygen functional groups (hydroxyl, carboxyl, and carbonyl groups) and the unreacted novolac epoxy or other impurity traces began to decompose.<sup>34,35</sup> The labile oxygen functional groups transformed into CO, CO<sub>2</sub>, and water vapor. As temperature further increased, the main decomposition process began and was attributed to the degradation of the cured novolac epoxy network.<sup>36,37</sup> From 450 °C to 600 °C, the skeleton of the carbon atoms began to degrade. As shown in Table 1 and Fig. 7, the 50% weight loss temperature increased as the weight percentage of modified GO in the composite increased. The corresponding temperature of the maximum weight loss rate gradually increased from 380 °C to 400 °C. In addition, the curves became restrained from 400 °C to 600 °C, illustrating the termination of the primary decomposition process. Throughout the whole 11 curves, the residue weight obtained at above 400 °C was directly proportional to the weight percentage of modified GO in the composite. Similarly, under the same residue weight, the corresponding temperature was directly proportional to the weight percentage of modified GO in the composite. This phenomenon was caused by interfacial bonding and the improved interface between the modified GO/novolac

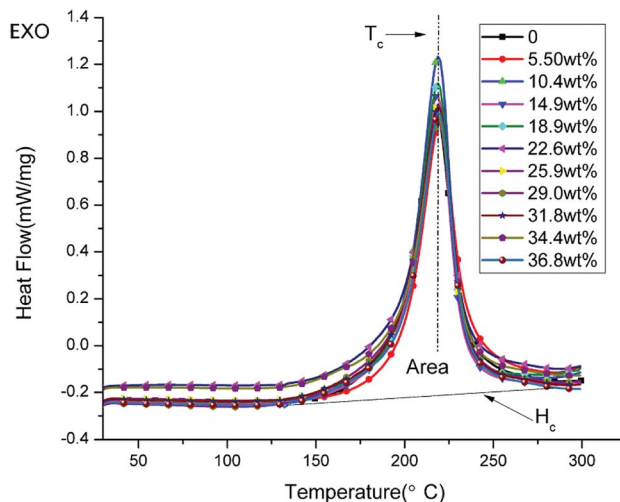


Fig. 6 DSC curves of novolac epoxy and modified GO/novolac epoxy composite.

epoxy composites. The barrier effect of the modified GO prevented the modified GO/novolac epoxy composite from decomposing.<sup>38</sup> Based on the above analyses, the thermal stability of the composites has been enhanced.

### 3.5 DSC

Fig. 6 shows the DSC curves of the uncured powders of novolac epoxy and uncured modified GO/novolac epoxy. The crystallization temperature  $T_c$  and the area of the exothermic peak  $H_c$  are shown in Table 2. The crystallization temperature  $T_c$  remained unchanged and only slightly fluctuated from 218 °C to 220 °C. When the composite contained 10.4 wt% modified GO, the released heat value  $H_c$  increased from 378.2 (J g<sup>-1</sup>) to 422 (J g<sup>-1</sup>), thus increasing by 43.8 (J g<sup>-1</sup>). This phenomenon illustrated that crystallization was facilitated by the modified GO. Then, the released heat decreased as the volume fraction increased but remained higher than that of pure resin.

### 3.6 DMA

Dynamic thermomechanical analysis is an analytical method that reflects the relationship between time, temperature, and

Table 1 TG data of novolac epoxy and thermal conductivity composite

Fillers content (wt%)	$T_{5\%}^a$ (°C)	$T_{50\%}^b$ (°C)	$T_{\max}^c$ (°C)	$R_{900}^d$ (%)
0	251	414	388	30.03
5.5	273	429	393	32.75
10.4	259	431	391	32.82
14.9	253	437	397	34.20
18.9	237	443	393	37.81
22.6	260	486	394	39.66
25.9	262	530	395	42.67
29	246	535	396	42.98
31.8	255	551	395	43.10
34.4	246	564	397	44.01
36.8	259	580	396	44.67

<sup>a</sup> Thermal degradation temperature of 5% weight loss. <sup>b</sup> Thermal degradation temperature of 50% weight loss. <sup>c</sup> Temperature of the maximum rate of degradation. <sup>d</sup> Residue weight at 900 °C.

Table 2 DSC data of novolac epoxy and modified GO/novolac epoxy composite

Fillers content (wt%)	$T_c$ (°C)	$H_c$ (J g <sup>-1</sup> )
0	218.0	378.2
5.5	219.7	390.8
10.4	219.0	422.0
14.9	218.3	386.3
18.9	218.7	392.0
22.6	218.8	399.5
25.9	218.6	391.5
29	219.1	392.0
31.8	219.0	392.9
34.4	218.9	384.3
36.8	219.3	381.8



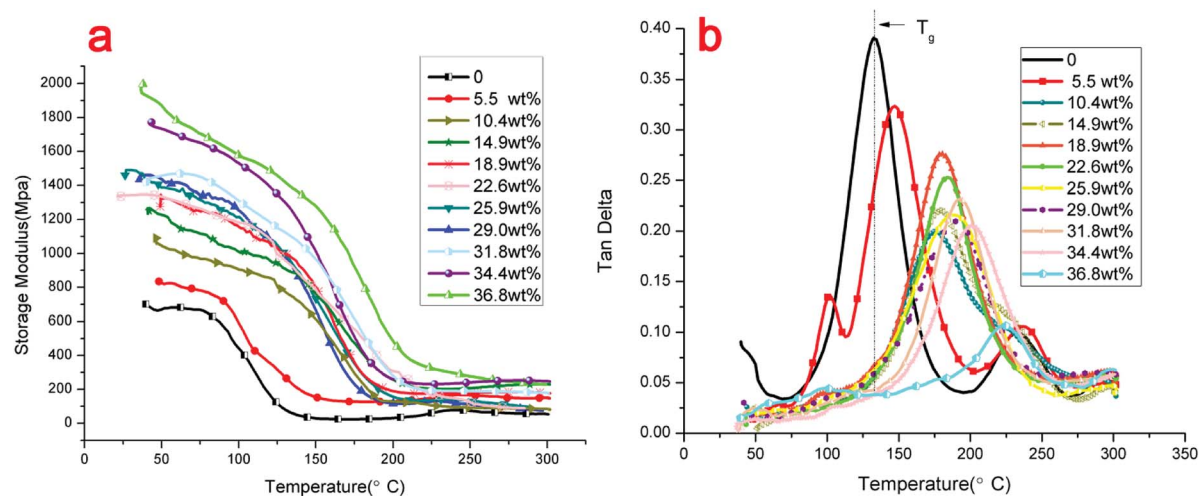


Fig. 7 Dynamic mechanical properties of novolac epoxy and modified GO/novolac epoxy composites: (a) storage modulus, (b) loss factor.

the mechanical property of viscoelastic material. Fig. 7(a) shows the storage modulus of the novolac epoxy and the modified GO/novolac epoxy composite. The storage modulus reflects the resilience of a material after deformation.<sup>39</sup> The results in Fig. 7(a) show that the glass transition of novolac epoxy terminated in the low-temperature zone, which ranged from approximately 75 °C to 140 °C. Then, the curve reached the minimum. This phenomenon likely resulted from the softening of the polymer chains. The corresponding temperature zone of the glass transition of the modified GO/novolac epoxy composite was 130 °C to 200 °C, which was almost 60 °C higher than that of novolac epoxy, when the weight percentage of modified GO in the composite reached 14.9%. This finding is mainly attributed to the internal crosslinking between the matrix and the filler.<sup>40</sup> The degree of crosslinking will increase with increasing volume fraction, thus strengthening energy storage. The movement of the polymer chain segment will be hindered under external stress. Therefore, the stiffness of the modified GO/novolac epoxy composite will increase.<sup>41</sup> When the weight percentage of modified GO in the composite increased to 22.6%, the value of the storage modulus of the modified GO/novolac epoxy composite increased by another order of magnitude. At this stage, the filler was extended throughout the whole matrix. Therefore, as inferred from the observation of the curves in the low-temperature region, the thermally conductive network efficiently prevented the movement of molecular chains. From approximately RT to 140 °C, a slight decrease resulted from secondary transition— $\beta$  transition,  $\gamma$  transition, and  $\delta$  transition—in the system. These transitions reflect the movement of the side chains and terminal groups in the polymer. As temperature increased from 140 °C to 200 °C, the curves sharply decreased because glass transition, which is the main transition (also referred to as  $\alpha$  transition) in this system occurred. At this stage, the main chains in the polymer began to move and caused considerable mechanical loss. After glass transition, the modified GO/novolac epoxy composite transitioned into a high elastic state and the storage modulus remained stable. The final storage modulus of composites with

high modified GO content was almost 200 MPa, which is significantly higher than that of novolac epoxy.

Fig. 7(b) shows the loss factor  $\tan \delta$ . The loss factor  $\tan \delta$  is the ratio of the loss modulus and storage modulus. The largest peak represents glass transition. During glass transition, the movement of molecular chains caused great internal friction. The loss modulus reached the maximum value at a certain temperature, which is defined as the glass transition temperature ( $T_g$ ). The glass transition temperature ( $T_g$ ) of each data set is shown in Table 3. As shown in Fig. 7(b), the glass transition region of the modified GO/novolac epoxy composite shifted to a higher temperature zone compared with that of novolac epoxy. This trend was consistent with the storage modulus shown in Fig. 7(a). The  $T_g$  for novolac epoxy was 132 °C. When the weight percentage of modified GO in the composite reached 36.8%, the  $T_g$  of the modified GO/novolac epoxy composite was 222 °C. Specifically, heat resistance improved by almost 90 °C with the addition of modified GO. As the weight percentage of modified GO in the composite increased from 0% to 36.8%, the overall trend of peak height gradually decreased due to the increasing loss modulus and decreasing storage modulus. This behavior is a characteristic of cross-linked polymers. However, the peak height exhibited a slightly irregular change from 14.9 wt% to

Table 3 Glass transition temperature ( $T_g$ ) of novolac epoxy and modified GO/novolac epoxy composite

Fillers content (wt%)	$T_g$ (°C)
0	132
5.5	147
10.4	176
14.9	178
18.9	180
22.6	185
25.9	189
29	190
31.8	192
34.4	202
36.8	222



29 wt% as a likely effect of the inevitable non-uniform distribution and localized clustering of fillers.<sup>42,43</sup> Then, the state of crosslinking could affect the loss modulus and storage modulus of the composite. Furthermore, the surface roughness of modified GO with corrugated morphology could also affect crosslinking. The wrinkled structure and large specific surface area of modified GO facilitated strong interfacial interactions with the matrix, even influencing the curing reaction rate.<sup>44,45</sup> Then, the degree of crosslinking could be influenced. Finally, the  $\tan \delta$  varied in a small range. The above analysis revealed that the addition of modified GO enhanced interfacial interaction between the filler and the matrix. The formed covalent bonds restricted the movement of the polymer chains.<sup>46,47</sup> The shifting of  $T_g$  confirmed that the crosslinking density of the thermal conductivity composite increased.<sup>48</sup> Therefore, the addition of modified GO improves the thermal stability and mechanical properties of the modified GO/novolac epoxy composite.

### 3.7 The interface between thermal conductive filler and novolac epoxy matrix

After the experiment of DMA, the surface morphology of sections was examined by SEM. Fig. 8(a) and (b) show the sections of composite filled with GO. It is shown that the pores and gaps between GO sheets and the matrix are clearly visible (Fig. 8(a)). The dispersion of GO in the matrix is not uniform enough. There is also a cluster of GO can be seen in Fig. 8(b). It is obvious that the interface between GO and the matrix is so bad that the GO and the matrix cannot combine tightly.

Therefore, it is hard to make the heat transfer effective because of the air which has the lowest thermal conductivity. In contrast, on the fracture surface of the composite containing modified GO, it is shown that the modified GO dispersed uniformly in the matrix and forms tortuous river-like structures, which can be inferred that the combination between filler and matrix has been improved. The tortuous river-like structures would restrict the micro-crack propagation in the composites.<sup>49</sup> The considerable fracture energy is likely to be dissipated as the formation of the tortuous river-like structures. With the functionalization improves the dispersion of GO and interfacial interaction between the filler and the matrix, the critical stress necessary to cause the sheet/sheet or sheet/matrix interfacial failure increases, thus lead to much more fracture energy dissipation.<sup>50,51</sup> Above all, functionalization of GO do improves both the dispersion and interface in the modified GO/novolac epoxy composite.

### 3.8 Thermal conductivity

Fig. 9 shows the experimental results for the modified GO/novolac epoxy composite and thermal conductivity models, including the Maxwell-Eucken,<sup>52</sup> Nielsen-Lewis,<sup>53</sup> Russell,<sup>54</sup> and Agari<sup>55</sup> models.

For the Maxwell-Eucken model:

$$\lambda_c = \lambda_1[(\lambda_2 + 2\lambda_1 + 2V_2(\lambda_2 - \lambda_1))/(\lambda_2 + 2\lambda_1 - V_2(\lambda_2 - \lambda_1))] \quad (1)$$

where,  $\lambda_c$  is thermal conductivity,  $\lambda_1$  is the thermal conductivity of matrix,  $\lambda_2$  is the thermal conductivity of filler,  $V$  is volume fraction.

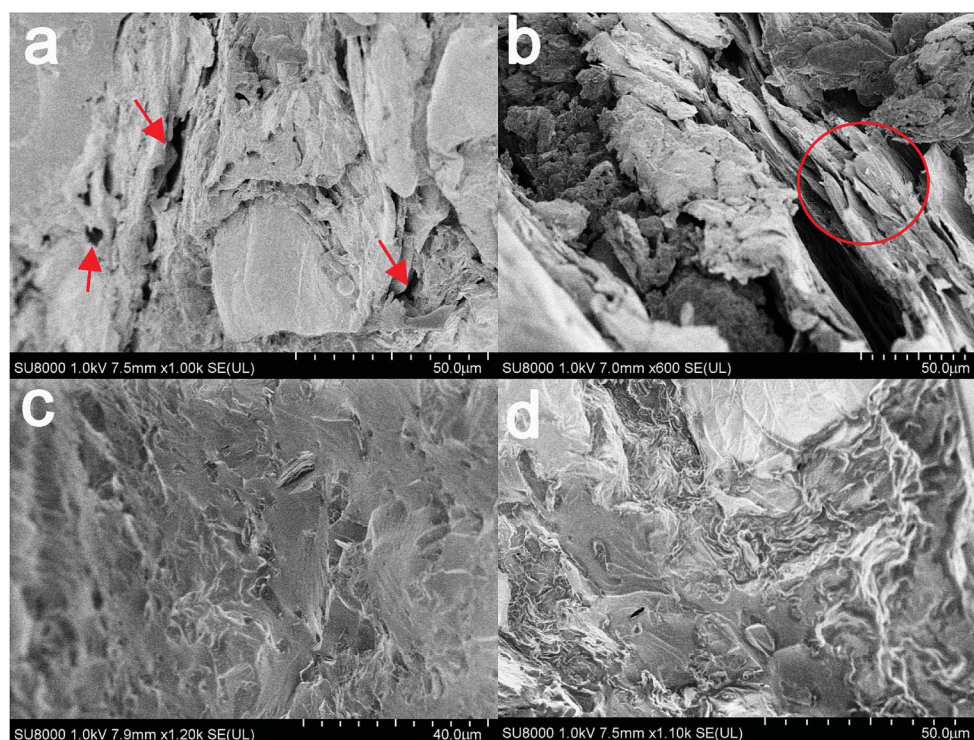


Fig. 8 SEM images of fracture surface of composite samples with 18.9 wt% (40 vol%) GO (a and b); 18.9 wt% (40 vol%) modified GO (c and d).





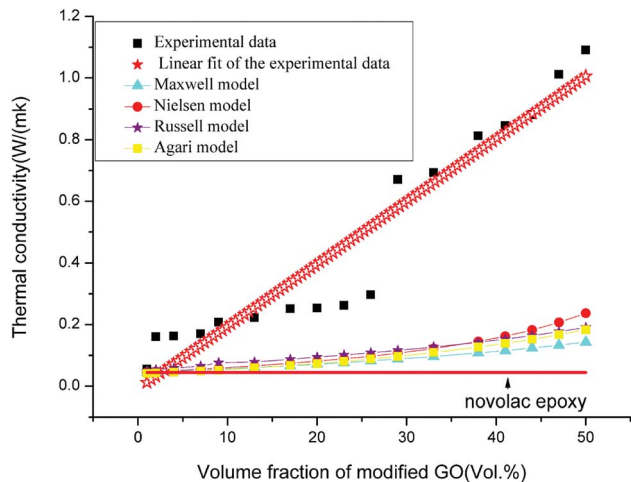


Fig. 9 Thermal conductivity curves of experimental data, thermal conductivity models, and prediction model.

For the Nielsen–Lewis model:

$$\frac{\lambda_c}{\lambda_1} = \frac{1 + ABV_2}{1 - B\varphi V_2} = > \lambda_c = \lambda_1 \frac{1 + ABV_2}{1 - B\varphi V_2} \quad (2)$$

where,

$$\varphi = 1 + \left[ \frac{1 - V_m}{V_m^2} \right] V_2$$

$$B = \frac{\frac{\lambda_2}{\lambda_1} - 1}{\frac{\lambda_2}{\lambda_1} + A}$$

$\lambda_c$  is thermal conductivity,  $\lambda_1$  is the thermal conductivity of matrix,  $\lambda_2$  is the thermal conductivity of filler,  $V$  is volume fraction.

$V_m$  is the maximum accumulation volume fraction of the dispersed filler, in general case, the values of  $V_m$  and  $A$  are set as 0.64 and 3.

For the Russell model:

$$\lambda_c = \lambda_1 \frac{V^{\frac{2}{3}} + \frac{\lambda_1}{\lambda_2(1 - V^{\frac{2}{3}})}}{V^{\frac{2}{3}} - V + \frac{\lambda_1}{\lambda_2(1 - V^{\frac{2}{3}})}} \quad (3)$$

where,  $\lambda_c$  is thermal conductivity,  $\lambda_1$  is the thermal conductivity of matrix,  $\lambda_2$  is the thermal conductivity of filler,  $V$  is volume fraction.

For the Agari model:

$$\log \lambda_c = (1 - V)\log(C_1\lambda_1) + VC_2 \log \lambda_2 \quad (4)$$

where, the coefficients  $C_1$  and  $C_2$  were taken from the work by Agari and Uno. In this work, they were 0.898 and 0.882, respectively.  $\lambda_c$  is thermal conductivity,  $\lambda_1$  is the thermal

conductivity of matrix,  $\lambda_2$  is the thermal conductivity of filler,  $V$  is volume fraction.

Fig. 9 shows the comparison of the values of the thermal conductivity models with the experimental data of the modified GO/novolac epoxy composite. In solid materials heat is carried by acoustic phonons.<sup>56</sup> Heat conduction in carbon materials is usually dominated by phonons even for graphite.<sup>57</sup> Under the volume fraction of 9%, the filler was encapsulated and remained isolated in the matrix, whereas the matrix was continuous. Therefore, the fillers could not touch each other at a low volume fraction.<sup>58</sup> At this stage the thermal conductivity of the composite increased slightly. At the stage of 9 vol% to 26 vol%, the thermal conductivity increased slowly but steadily. The filler allowed the conduction of phonons over short distance as the volume fraction of filler is not high enough.<sup>59</sup> At the same time a locally thermal conductive network was formed as fillers started to come in contact with each other. With the further addition of modified GO, an inter-connected thermal conductive network was formed over the whole matrix, which was consist of locally thermal conductive network. When the volume fraction of modified GO in the composite varied from 26% to 29%, the thermal conductivity of the modified GO/novolac epoxy composite was 0.671 W m<sup>-1</sup> K<sup>-1</sup>, which was almost 2.3 times that of 26 vol%'s. Therefore, 26 vol% is the percolation threshold in this heat conduction system.<sup>60</sup> At the last stage, the thermal conductive network was gradually formed in the entirety of the resin matrix. That's because the fillers scattered in the matrix densely. So they came into contact with each other and transmit heat to the composite, under the help of phonons. The thermal conductivity of the composite increased rapidly from 0.671 W m<sup>-1</sup> K<sup>-1</sup> to 1.091 W m<sup>-1</sup> K<sup>-1</sup> with the incorporation of 29 vol% to 50 vol% modified GO. At the last stage of volume increase, the thermal conductivity continued to increase at a slower rate, illustrating that the increase in volume fraction is one of the factors that affect thermal conductivity at this stage. The decrease in interfacial adhesion between the matrix and the fillers, dispersion of fillers, interfacial thermal resistance between the fillers and matrix and the bubbles produced in the hot pressing process will also affect the final thermal conductivity of the modified GO/novolac epoxy composite by various degrees.

Observing the predictive model curves revealed that the four models exhibited the same trend with experimental data before the addition of 29 vol% modified GO in the composite. In this stage, the curves exhibited gradual linear growth. The growth trend then deviated from the experimental data because of various reasons: The Maxwell–Eucken model assumes that the particle is spherical in shape and ignores the high volume fraction and the gap of thermal conductivity between the matrix and filler. In this study, the thermal conductivity of the novolac epoxy was only 0.044 W m<sup>-1</sup> K<sup>-1</sup>. The considerable gap between the filler and matrix should not be neglected. The Nielsen model is appropriate for heat conduction systems with low levels of filler, and the constants  $A$  and  $B$  are summarized from previous data. Based on the consistent growth trend between the Nielsen model and experimental data, we can infer that if the proper constants  $A$  and  $B$  are found, the Nielsen model



could fit the experimental data well for the composites that contain low volume fractions of modified GO. The Russell model assumes that the dispersed phase is also scattered in the matrix with the same size and remains in isolation, which violates the theory of the thermal conductive network analyzed above. The deviation in the Agari model may be caused by constants  $C_1$  and  $C_2$ , which may vary in different systems.<sup>61</sup> The characterization of constants  $C_1$  and  $C_2$  requires detailed investigation.

A simple and practical characteristic model is obtained by fitting the experimental data. The equation of the model is as follows:

$$\lambda_c = 0.011V + 0.077 \quad (5)$$

where,  $V$  is the volume fraction.

The above analysis shows that the growth process of thermal conductivity can be divided into three stages. In the first stage, the thermal conductivity increased slowly but steadily. The filler remained almost isolated. In the second stage, the thermal conductive network was gradually formed over the entirety of the resin matrix. In the third stage, the thermal conductivity continued to increase at a slow rate. When the volume fraction reached 50%, the thermal conductivity remained at  $1.091 \text{ W m}^{-1} \text{ K}^{-1}$ , which is 24.8-fold that of novolac epoxy. The increase in thermal conductivity of the composite with increasing concentration of modified GO could be attributed to the following factors: the inter-connected thermal conductive propagation in modified GO mainly resulted from acoustic phonons.<sup>62</sup> After being modified, in comparison with the pure GO, functionalization of the GO sheets leads in the improvement of the phonon coupling of functionalized GO and novolac epoxy.<sup>63</sup> A similar phenomenon was also observed in Gu's work.<sup>64</sup> The noticeable improvement of thermal conductivity showed that the modified GO has an important role in inhibiting aggregation and facilitating dispersion in the matrix.<sup>65</sup> The uniform dispersion and thermal conductive pathways of the matrix contributed to the increase in thermal conductivity. Therefore, the incorporation of modified GO in novolac epoxy improves the thermal conductivity of the modified GO/novolac epoxy composite.

## 4. Conclusion

A facile GO functionalization method was reported in this paper. Samples of modified GO/novolac epoxy composite were prepared with different volume fractions of modified GO. The results from FTIR, SEM, and TEM confirmed that the ring-opened TGIC was successfully grafted on GO. The filler dispersed in the matrix well due to good interfacial interaction. The addition of modified GO improved the energy storage capacity of the modified GO/novolac epoxy composite because of molecular crosslinking between the filler and matrix. The DMA data demonstrated that when the weight percentage of modified GO in novolac epoxy reached 36.8% the modified GO/novolac epoxy composite had a  $T_g$  value of  $222^\circ\text{C}$ , which was  $90^\circ\text{C}$  higher than that of novolac epoxy. Moreover, TGA analysis

was performed to illustrate the decomposition mechanism of the modified GO/novolac epoxy composite. The TGA data showed that the temperature of the maximum degradation rate improved by  $12^\circ\text{C}$ . The thermal conductivity of the modified GO/novolac epoxy composite reached  $1.091 \text{ W m}^{-1} \text{ K}^{-1}$ , which was 25 times higher than that of novolac epoxy, when the composite was modified with 50 vol% modified GO. The above results illustrated that the addition of modified GO to novolac epoxy improved various properties and can possibly be applied to other similar thermal interface materials.

## Conflicts of interest

There are no conflicts to declare.

## Acknowledgements

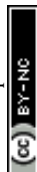
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